

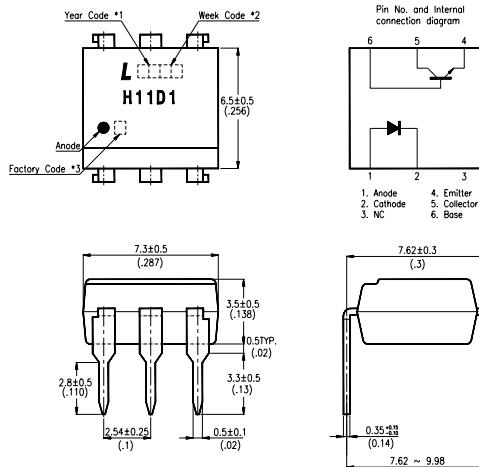
Features

- Current transfer ratio
(CTR : MIN. 20% at $I_F = 10\text{mA}$, $V_{CE} = 10\text{V}$)
- High isolation voltage between input and output
($V_{ISO} = 5,000 \text{ Vrms}$)
- High collector-emitter breakdown voltage
($BV_{CER} = 300\text{V}$)
- UL approved (No. E113898)
- VDE approved (No. 094722)
- CSA approve in progress
- Options Available :
 - Leads with 0.4" (10.16mm) Spacing (M Type)
 - Lead Bends for Surface Mounting (S Type)
 - Tape and Reel of Type I for SMD (Add "-TA" Suffix)
 - Tape and Reel of Type II for SMD (Add "-TA1" Suffix)
 - VDE 0884 Approvals (Add "-V" Suffix)

Applications

1. Copy Machines
2. Interfacing and coupling systems of different potentials and impedances
3. Monitor and detection circuits
4. Solid state relays

Package Dimensions



NOTES :

1. Year date code.
2. 2-digit work week.
3. Factory code shall be marked (Z : Taiwan, Y : Thailand).
4. All dimensions are in millimeters (inches).
5. Tolerance is $\pm 0.25\text{mm}$ (.010") unless otherwise noted.
6. Specifications are subject to change without notice.

Ordering Information

Part Number	Package	Safety Standard Approval	Application part number
H11D1 H11D1M H11D1S H11D1S-TA H11D1S-TA1	6-pin DIP 6-pin (leads with 0.4" spacing) 6-pin (lead bends for surface mount) 6-pin (tape and reel packaging of type I) 6-pin (tape and reel packaging of type II)	• UL approved • CSA approve in progress	H11D1
H11D1-V H11D1M-V H11D1S-V H11D1STA-V H11D1STA1-V	6-pin DIP 6-pin (leads with 0.4" spacing) 6-pin (lead bends for surface mount) 6-pin (tape and reel packaging of type I) 6-pin (tape and reel packaging of type II)	• VDE approved	H11D1

Ratings and Characteristics

Absolute Maximum Ratings

(Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward Current	I _F	60	mA
	Reverse Voltage	V _R	6	V
	Power Dissipation	P	100	mW
Output	Collector-Emitter Voltage	V _{C EO}	300	V
	Emitter-Collector Voltage	V _{E CO}	7	V
	Collector-Base Voltage	V _{C BO}	300	V
	Emitter-Base Voltage	V _{E BO}	7	V
	Collector Current	I _C	100	mA
	Collector Power Dissipation	P _C	150	mW
Total Power Dissipation		P _{tot}	250	mW
*1.Isolation Voltage		V _{iso}	5,000	Vrms
Operating Temperature		T _{opr}	-55~+100	°C
Storage Temperature		T _{stg}	-55~+150	°C
*2.Soldering Temperature		T _{sol}	260	°C

*1. AC for 1 minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

*2. For 10 seconds

Electrical / Optical Characteristics

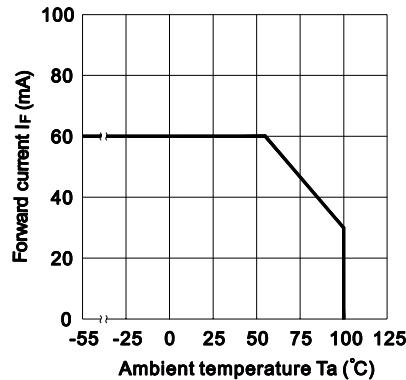
(Ta=25°C)

Parameter		Symbol	Min.	Typ.	Max.	unit	Conditions
Input	Forward Voltage	V _F	—	1.2	1.5	V	I _F =10mA
	Reverse Current	I _R	—	0.01	10	μA	V _R =6V
	Terminal Capacitance	C _t	—	30	250	pF	V=0, f=1KHz
Output	Collector Dark Current	I _{CER}	—	—	100	nA	V _{C E} =200V, R _{BE} =1MΩ
	Collector-Emitter Breakdown Voltage	BV _{CER}	300	—	—	V	I _C =0.1mA, I _F =0 R _{BE} =1MΩ
	Emitter-Collector Breakdown Voltage	BV _{ECO}	7	—	—	V	I _E =10 μA I _F =0mA
Transfer Characteristics	Collector Current	I _C	2	—	—	mA	I _F =10mA V _{C E} =10V R _{BE} =1MΩ
	*1 Current Transfer Ratio	CTR	20	—	—	%	
	Collector-emitter Saturation Voltage	V _{C E(sat)}	—	0.25	0.4	V	I _F =10mA, I _C =0.5mA R _{BE} =1MΩ
	Isolation Resistance	R _{iso}	5 × 10 ¹⁰	—	—	Ω	DC500V 40~60% R.H.
	Floating Capacitance	C _f	—	0.6	—	pF	V=0, f=1MHz
	Response Time (Rise)	t _r	—	5	—	μ s	V _{CC} =10V, I _C =2mA R _L =100Ω
	Response Time (Fall)	t _f	—	5	—	μ s	

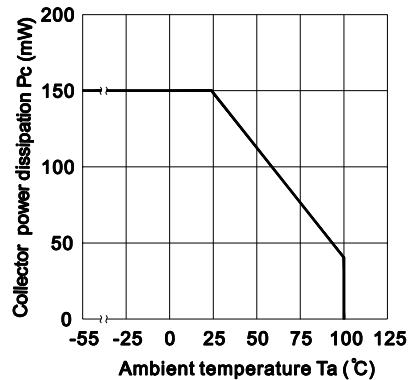
$$*1. CTR = \frac{I_C}{I_F} \times 100\%$$

Typical Electrical/Optical Characteristic Curves (25°C Ambient Temperature Unless Otherwise Noted)

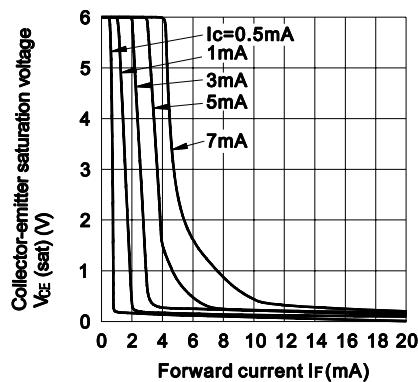
**Fig.1 Forward Current vs.
Ambient Temperature**



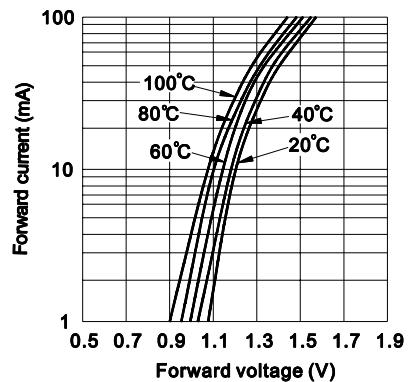
**Fig.2 Collector Power Dissipation vs.
Ambient Temperature**



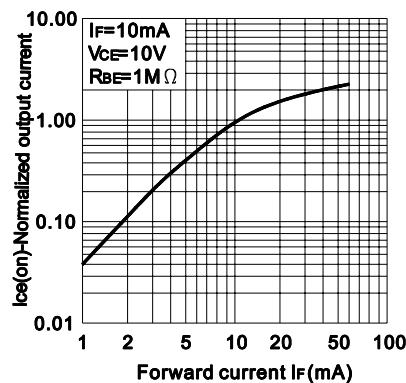
**Fig.3 Collector-emitter saturation
Voltage vs. Forward current**



**Fig.4 Forward Current vs. Forward
Voltage**



**Fig.5 Output Current vs.
Forward Current Curve**



**Fig.6 Collector Current vs.
Collector-emitter Voltage**

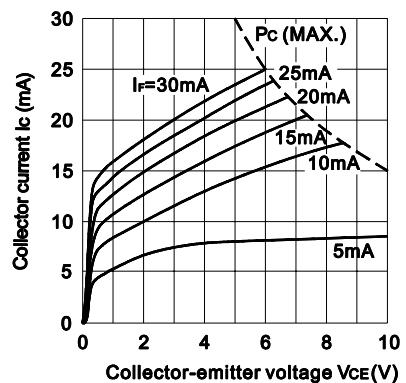


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

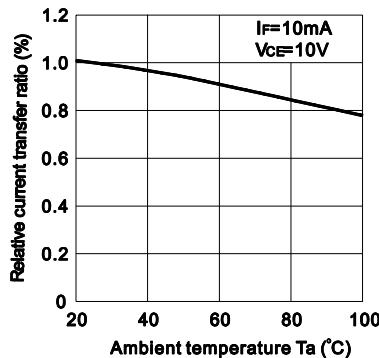


Fig.9 Collector Dark Current vs. Ambient Temperature

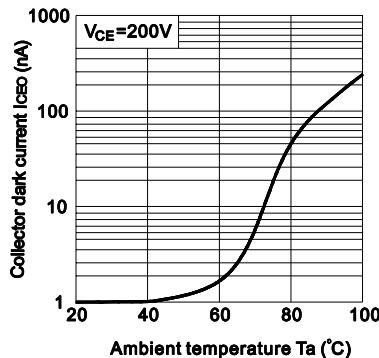


Fig.11 Frequency Response

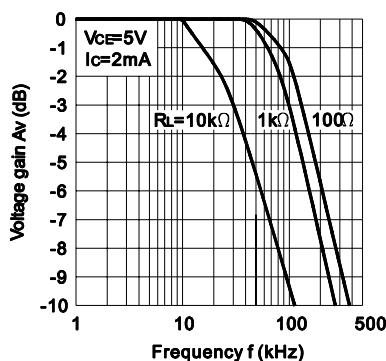


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

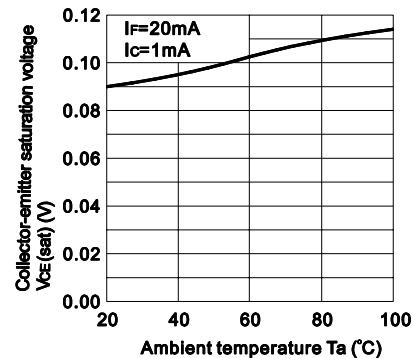
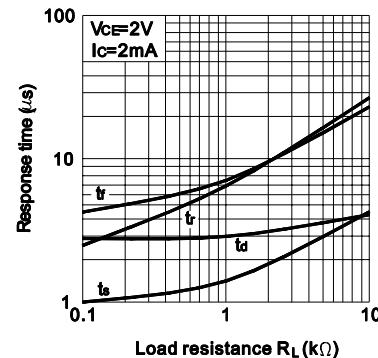
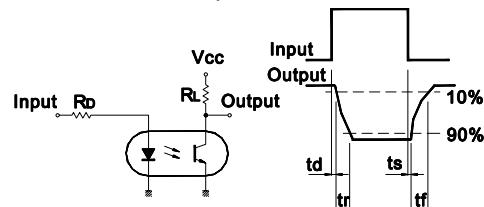


Fig.10 Response Time vs. Load Resistance



Test Circuit for Response Time



Test Circuit for Frequency Response

